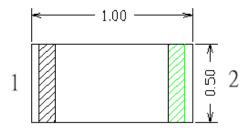
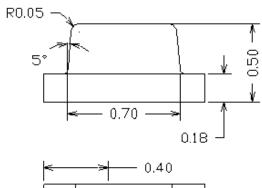
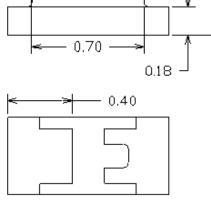


1.0 x 0.5 x 0.5mm Red SMD LED

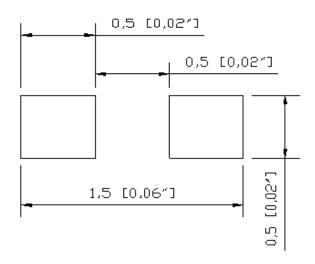
## **PACKAGE OUTLINES**

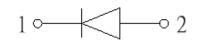






## RECOMMEND PAD LAYOUT





Item	Material
Resin(Mold)	Ероху
Lens Color	Water Transparent
Dice	AlGaInP/GaAs
Emitted Color	Red

#### Notes:

- 1. All dimensions are in millimeters (inches)
- 2. Tolerances are  $\pm 0.1$ mm (0.004inch) unless otherwise noted



1.0 x 0.5 x 0.5mm Red SMD LED

## **ABSOLUTE MAXIMUM RATINGS**

(Ta=25°C)

	Symbol	Value	Unit
Forward Current	I <sub>F</sub>	30	mA
Reverse Voltage	Vr	5	V
Power Dissipation	$P_{D}$	75	mW
Operating Temperature Range	T <sub>op</sub>	-40~+80	°C
Storage Temperature Range	$T_{stg}$	-40~+85	°C
Peak Pulsing Current (1/8 duty f=1kHz)	I <sub>fp</sub>	125	mA

## **OPTICAL-ELECTRICAL CHARACTERISTICS**

(Ta=25°C)

	Symbol	Test Condition	Min	Тур	Max	Unit
Wavelength at peak emission	$\lambda_{p}$			640		nm
Spectral Half bandwidth	$\Delta_{\lambda}$			18	-	nm
Dominant Wavelength	λd	lf=20mA	625	630	635	nm
Forward Voltage	V <sub>f</sub>		1.7	2.0	2.5	V
Luminous Intensity	lv		50	100	160	mcd
Viewing Angle at 50% Iv	2Θ1/2	If=10mA		140		deg
Reverse Current	I <sub>r</sub>	Vr=5V			10	μΑ



1.0 x 0.5 x 0.5mm Red SMD LED

**Forward Voltage Rank** 

(IF=20mA)

Rank	Min.	Max.	Unit
	1.7	2.5	V

**Luminous Intensity Rank** 

(IF=20mA)

			\ /
Rank	Min.	Max.	Unit
G	50	63	
Н	63	80	
I	80	100	mcd
J	100	125	
K	125	160	

**Dominant Wavelength Rank** 

(IF=20mA)

Rank	Min.	Max.	Unit
u	625	630	nm
V	630	635	nm

Group Name on Label (Example DATA: □Jv 20)

DATA: □Jv 20	Vf(V)	lv (mcd)	λd (nm)	Test Condition
□→ J→ v →20	1.7 ~ 2.5	100~125	630~635	IF= 20mA

#### Notes:

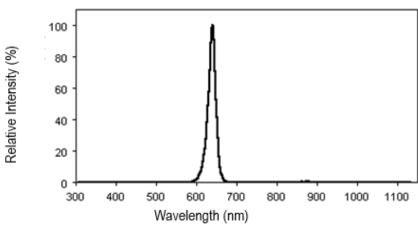
- 1. Tolerance of luminous intensity (Iv) is ±15%
- 2. Tolerance of Dominant wavelength is ± 1.5nm
- 3. This specification is preliminary



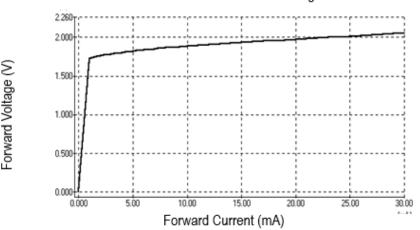
1.0 x 0.5 x 0.5mm Red SMD LED

## **OPTICAL CHARACTERISTIC CURVES**

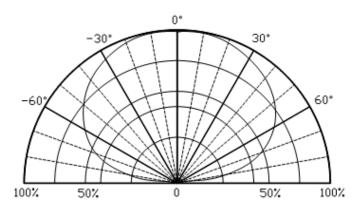




#### Forward Current vs. Forward Voltage



#### Directive Characteristics

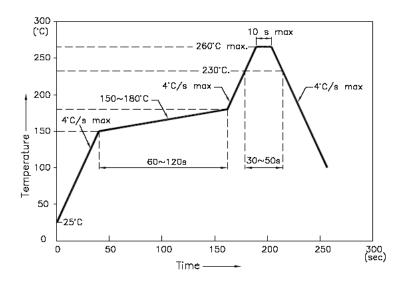




1.0 x 0.5 x 0.5mm Red SMD LED

#### **REFLOW PROFILE**

#### Reflow Temp/Time



#### Notes:

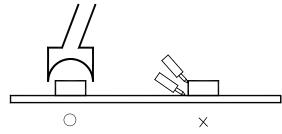
- 1. We recommend the reflow temperature 245°C (±5°C).the maximum soldering temperature should be limited to 260°C.
- 2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

#### Soldering iron

Basic spec is ≤ 5sec when 260°C. If temperature is higher, time should be shorter (+10°C → -1sec). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under 230°C.

#### Rework

- Customer must finish rework within 5 seconds under 260°C
- 2. Head of iron cannot touch coper foil
- 3. Twin-head type is preferred



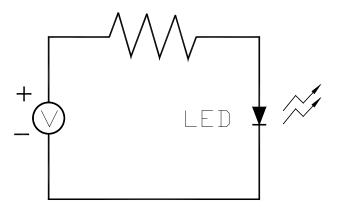
 Avoid rubbing or scraping the resin by any object during high temperature, for example, reflow solder etc.



1.0 x 0.5 x 0.5mm Red SMD LED

#### **TEST CIRCUIT AND HANDLING PRECAUTIONS**

## Test circuit



## Handling precautions

- Over-current-proof
  Customer must apply resistors for protection; otherwise slight voltage shift will cause big
  current change (Burn out will happen).
- 2. Shelf life in sealed bag: 12 month at 5°C ~30°C and < 60% RH
- 3. After package is opened:
  - 3.1. It is recommended to baking before the first use:

#### Baking condition:

- a.  $60\pm5$ °C x (24~48hrs) and < 5%RH, taped reel type
- b. 110±5°C x (8~16hr), bulk type
- 3.2 The products should be used within a week and to be stored at ≦20% R.H. with zip-lock sealed:
- a. Baking is required before soldering when the pack is unsealed after 24hrs
- b. Baking condition as 3.1 baking condition



1.0 x 0.5 x 0.5mm Red SMD LED

## **TEST AND RESULTS OF RELIABLITY**

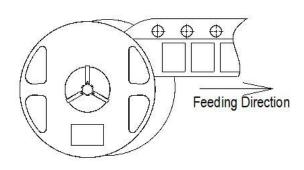
Туре	Test Item	Test Conditions	Note	Number of Damaged
	Temperature Cycle	-20°C 30min ↑↓ 80°C 30min	100 cycle	0/22
	Thermal Shock	-20°C 15min ↑↓ 80°C 15min	100 cycle	0/22
Environmental Sequence	High Humidity Heat Cycle	30°C⇔ 65°C 90%RH 24hrs/1cycle	10 cycle	0/22
Enviror Sequ	High Temperature Storage	T <sub>a</sub> =80°C	1000 hrs	0/22
	Humidity Heat Storage	T <sub>a</sub> =60°C RH=90%	1000 hrs	0/22
	Low Temperature Storage	T <sub>a</sub> =-30°C	1000 hrs	0/22
	Life Test	T <sub>a</sub> =25°C I <sub>F</sub> =20mA	1000 hrs	0/22
<b>Operation</b> <b>Sequence</b>	High Humidity Heat Life Test	60°C RH=90% I <sub>F</sub> =10mA	500 hrs	0/22
S	Low Temperature Life Test	T <sub>a</sub> =-20°C I <sub>F</sub> =20mA	1000 hrs	0/22



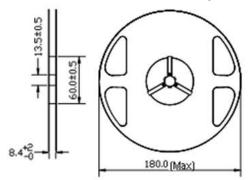
1.0 x 0.5 x 0.5mm Red SMD LED

#### PACKAGING SPECIFICATION

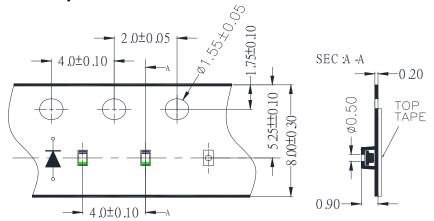
Feeding Direction



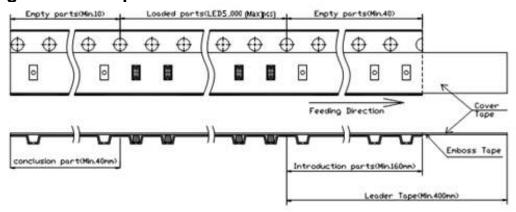
Dimensions of Reel (Unit: mm)



Dimensions of Tape



Arrangement of Tape



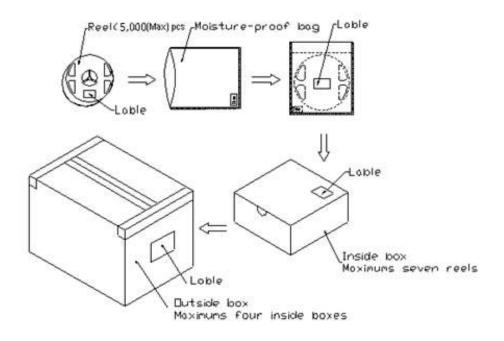
#### Notes:

- 1. Empty component pockets are sealed with top cover tape
- 2. The maximum number of missing lamps is two
- 3. The cathode is oriented towards the tape sprocket hole
- 4. 5,000 (max) pcs/Reel



1.0 x 0.5 x 0.5mm Red SMD LED

#### PACKAGING SPECIFICATION



#### NOTES:

Reeled products [numbers of products are 5,000(Max)pcs] packed in a seal off moisture-proof bag along with a desiccant one by one, Seven moisture-proof bag of maximums [total maximum number of products are 35,000(Max)pcs] packed in an inside box (size: about 238mm x about 194mm x about 102mm) and four inside boxes of maximums are put in the outside box (size: about 410mm x about 254mm x about 229mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.